VS-80EBU02



Vishay Semiconductors

Ultrafast Soft Recovery Diode, 80 A FRED Pt®



PowerTab[®]

PRODUCT SUMMARY					
Package PowerTab [®]					
I _{F(AV)}	80 A				
V _R	200 V				
V _F at I _F	1.13 V				
t _{rr} (typ.)	See recovery table				
T _J max.	175 °C				
Diode variation	Single die				

FEATURES

- Ultrafast recovery time
- 175 °C max. operating junction temperature
- Screw mounting only
- Designed and qualified according to JEDEC-JESD47
- Compliant to RoHS Directive 2002/95/EC
- PowerTab[®] package

BENEFITS

- Reduced RFI and EMI
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION/APPLICATIONS

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems.

The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

Pb-free



ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	V _R		200	V	
Continuous forward current	I _{F(AV)}	T _C = 112 °C	80		
Single pulse forward current	I _{FSM}	T _C = 25 °C	800	А	
Maximum repetitive forward current	I _{FRM}	Square wave, 20 kHz	160		
Operating junction and storage temperatures	T _J , T _{Stg}		- 55 to 175	°C	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS MIN. TYP. MAX.		UNITS		
Breakdown voltage, blocking voltage	V _{BR} , V _r	$I_{\rm P} = 50 \text{uA}$		-	-	
Forward voltage V	V _F	I _F = 80 A		0.98	1.13	V
	۷F	I _F = 80 A, T _J = 175 °C	-	0.79	0.92	
		$V_{R} = V_{R}$ rated	-	-	50	μA
Reverse leakage current	I _R	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	2	mA
Junction capacitance	CT	V _R = 200 V		89	-	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body - 3.5 -		nH		

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1

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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CON	MIN.	TYP.	MAX.	UNITS	
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	-	35	
Reverse recovery time t _{rr}	T _J = 25 °C		-	32	-	ns	
		T _J = 125 °C		-	52	-	
Peak recovery current		T _J = 25 °C	I _F = 80 A V _R = 160 V dI _F /dt = 200 A/μs	-	4.4	-	A
	I _{RRM}	T _J = 125 °C		-	8.8	-	
Reverse recovery charge Q _{rr}	0	T _J = 25 °C		-	70	-	nC
	Q _{rr}	T _J = 125 °C		-	240	-	10

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance, junction to case	R _{thJC}		-	-	0.70	K/W
Thermal resistance, junction to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.2	-	N/ VV
Weight			-	-	5.02	g
weight			-	0.18	-	oz.
Mounting torque			1.2 (10)	-	2.4 (20)	N · m (lbf · in)
Marking device		Case style PowerTab®		80EI	3U02	





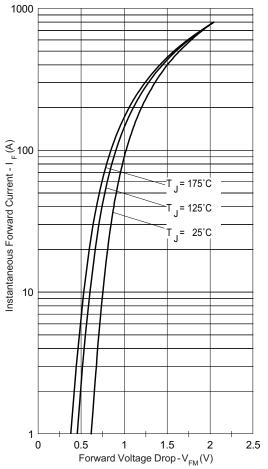


Fig. 1 - Maximum Forward Voltage Drop Characteristics

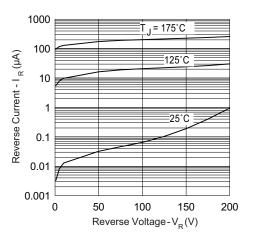


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

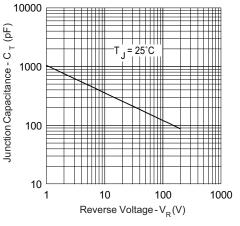
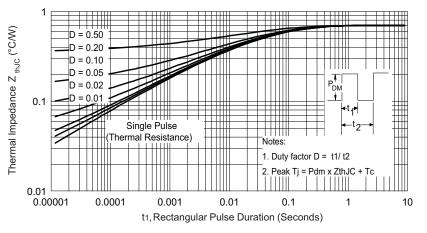


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage







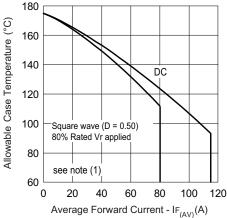
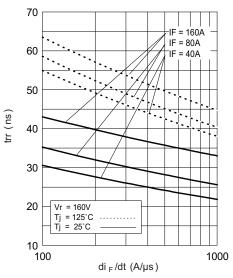


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current





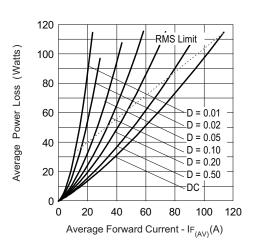
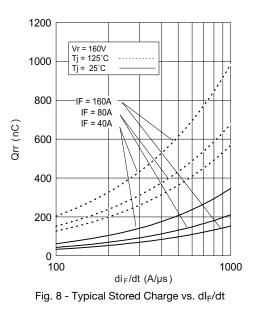


Fig. 6 - Forward Power Loss Characteristics



Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

 $\begin{array}{l} \mathsf{Pd} = \mathsf{Forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \times \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see fig. 6}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{Inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \times \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} - \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{80} \ \% \ \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$

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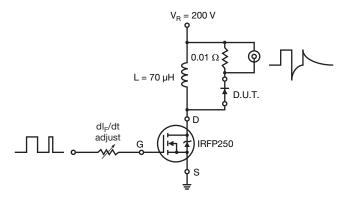


Fig. 9 - Reverse Recovery Parameter Test Circuit

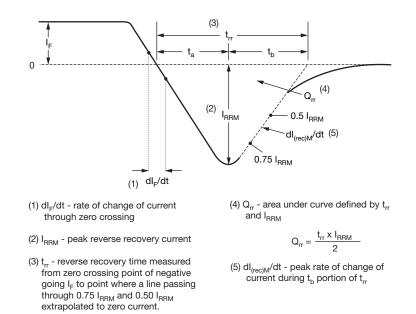


Fig. 10 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE

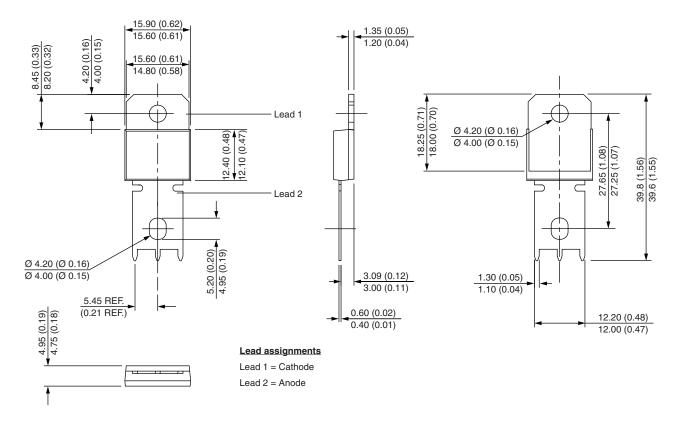
Device code	VS-	80	Е	В	U	02
	1	2	3	4	5	6
	1 -		nay Sem			oduct
	2 - 3 -		rent rati gle diode	0 (- 00 A)	
	4 -	Pov	verTab®	(ultrafa	st/hyper	fast only)
	5 -	Ultr	afast ree	covery		
	6 -	Vol	tage rati	ng (02 =	= 200 V)	

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95240				
Part marking information	www.vishay.com/doc?95370			
Application note	www.vishay.com/doc?95179			



PowerTab[®]

DIMENSIONS in millimeters (inches)





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